



Patent

Attorney Docket No. 1003510-000161

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Yoshihisa Saimoto et al.

Application No.: 10/506,806 ✓

Filing Date: September 7, 2004

Title: PRESSURE SENSITIVE ADHESIVE  
FILM FOR PROTECTION OF  
SEMICONDUCTOR WAFER  
SURFACE AND METHOD OF  
PROTECTING SEMICONDUCTOR  
WAFER WITH THE PRESSURE  
SENSITIVE ADHESIVE FILM

MAIL STOP AF

Group Art Unit: 2811

Examiner: Steven H. Yin Loke

Confirmation No.: 5415

## AMENDMENT/REPLY TRANSMITTAL LETTER

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Enclosed is a reply for the above-identified patent application.

- ☐ A Petition for Extension of Time is enclosed.
- ☐ \_\_\_\_\_ Terminal Disclaimer(s) and the ☐ \$ 65 ☐ \$ 130 fee per Disclaimer due under 37 C.F.R. § 1.20(d) are enclosed.
- ☒ Also enclosed is a Japanese language and English translation of the Japanese Industrial Standard "Cold Rolled Stainless Steel Plates, Sheets and Strip".
- ☐ Small entity status is hereby claimed.
- ☐ Applicant(s) requests continued examination under 37 C.F.R. § 1.114 and enclose the ☐ \$ 395 ☐ \$ 790 fee due under 37 C.F.R. § 1.17(e).
- ☐ Applicant(s) requests that any previously unentered after final amendments not be entered. Continued examination is requested based on the enclosed documents identified above.
- ☐ Applicant(s) previously submitted \_\_\_\_\_ on \_\_\_\_\_ for which continued examination is requested.
- ☐ Applicant(s) requests suspension of action by the Office until at least \_\_\_\_\_, which does not exceed three months from the filing of this RCE, in accordance with 37 C.F.R. § 1.103(c). The required fee under 37 C.F.R. § 1.17(i) is enclosed.

- ☐ A Request for Entry and Consideration of Submission under 37 C.F.R. § 1.129(a) (1809/2809) is also enclosed.
- ☒ No additional claim fee is required.
- ☐ An additional claim fee is required, and is calculated as shown below:


AMENDED CLAIMS					
	No. of Claims	Highest No. of Claims Previously Paid For	Extra Claims	Rate	Additional Fee
Total Claims	4	20	0	x \$ 50 (1202)	\$ 0
Independent Claims	2	3	0	x \$ 200 (1201)	0
<input type="checkbox"/> If Amendment adds multiple dependent claims, add \$ 360 (1203)					\$ 0
<b>Total Claim Amendment Fee</b>					<b>\$ 0</b>
<input type="checkbox"/> Small Entity Status claimed - subtract 50% of Total Claim Amendment Fee					0
<b>TOTAL ADDITIONAL CLAIM FEE DUE FOR THIS AMENDMENT</b>					<b>\$ 0</b>

- ☐ Charge \_\_\_\_\_ to Deposit Account No. 02-4800 for the fee due.
- ☐ A check in the amount of \_\_\_\_\_ is enclosed for the fee due.
- ☐ Charge \_\_\_\_\_ to credit card for the fee due. Form PTO-2038 is attached.
- ☒ The Director is hereby authorized to charge any appropriate fees under 37 C.F.R. §§ 1.16, 1.17 and 1.20(d) and 1.21 that may be required by this paper, and to credit any overpayment, to Deposit Account No. 02-4800. This paper is submitted in duplicate.

Respectfully submitted,

BUCHANAN INGERSOLL & ROONEY PC

Date November 9, 2006

By:   
Robert G. Mukai  
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P.O. Box 1404  
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Patent  
Attorney's Docket No. 1003510-000161

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of	) <b>MAIL STOP AF</b>
Tsutomu Saimoto et al.	)
Application No.: 10/506,806	) Group Art Unit: 2811
Filed: September 7, 2004	) Examiner: Steven Ho Yin Loke
For: PRESSURE SENSITIVE ADHESIVE	) Confirmation No.: 5415
FILM FOR PROTECTION OF	)
SEMICONDUCTOR WAFER	)
SURFACE AND METHOD OF	)
PROTECTING SEMICONDUCTOR	)
WAFER WITH THE PRESSURE	)
SENSITIVE ADHESIVE FILM	)

**AMENDMENT AND SUBMISSION OF TECHNICAL INFORMATION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed August 9, 2006, please amend the  
above-identified application as follows: